

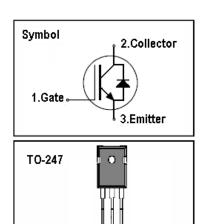
IGBT

Features

- 1200V 25A
- $V_{CE(sat)(typ.)}$ =2.1V @ V_{GE} =15V, I_{C} =25A
- High speed switching
- Higher system efficiency
- Soft current turn-off waveforms
- Square RBSOA

General Description

JIAEN Trench IGBTs offer lower losses and higher energy efficiency for application such as IH (induction heating),UPS, general inverter and other soft switching applications.



GCE

Absolute Maximum Ratings

Symbol	Parameter	Value	Units	
V _{CES}	Collector-Emitter Voltage	1200	V	
V_{GES}	Gate-Emitter Voltage	<u>+</u> 30	V	
	Continuous Collector Current (Tc=25 °C)	50	А	
Ic	Continuous Collector Current (Tc=100°C)	25	А	
I _{CM}	Pulsed Collector Current (Note 1)	75	Α	
I _F	Diode Continuous Forward Current (Tc=100 °C)	25	А	
I _{FM}	Diode Maximum Forward Current (Note 1)	75	А	
t_{sc}	Short Circuit Withstand Time	10	us	
Б	Maximum Power Dissipation (T _C =25 °C)	277	W	
P _D	Maximum Power Dissipation (T _C =100°C)	111	W	
ТJ	Operating Junction Temperature Range -40 to +155 °C		$^{\circ}$	
T_{STG}	Storage Temperature Range -55 to +155		$^{\circ}$ C	

Thermal Characteristics

Symbol	Parameter	Max.	Units	
R _{th j-c}	Thermal Resistance, Junction to case for IGBT	0.45	°C/ W	
R _{th j-c}	R _{th j-c} Thermal Resistance, Junction to case for Diode		°C/ W	
R _{th j-a}	R _{th j-a} Thermal Resistance, Junction to Ambient		°C/ W	

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Electrical Characteristics (Tc=25 °C unless otherwise noted)

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Units
BV _{CES}	Collector-Emitter Breakdown Voltage	$V_{GE} = 0V, I_{C} = 250uA$	1200	-	-	V
I _{CES}	Collector-Emitter Leakage Current	V _{CE} = 1200V, V _{GE} = 0V	-	-	100	uA
	Gate Leakage Current, Forward	V_{GE} =30V, V_{CE} = 0V	-	-	100	nA
I _{GES}	Gate Leakage Current, Reverse	V_{GE} = -30V, V_{CE} = 0V	-	-	100	nA
$V_{\text{GE(th)}}$	Gate Threshold Voltage	$V_{GE} = V_{CE}$, $I_C = 250uA$	4.5	-	6.5	V
$V_{\text{CE(sat)}}$	Collector-Emitter Saturation Voltage	V_{GE} =15V, I_{C} = 25A	1	2.1	2.5	V
Qg	Total Gate Charge	Vcc=600V	-	200		nC
Q _{ge}	Gate-Emitter Charge	V _{GE} =15V	-	15		nC
Qgc	Gate-Collector Charge	Ic=25A	-	80		nC
t d(on)	Turn-on Delay Time	V_{CC} =600 V V_{GE} =15 V I_{C} =25 A R_{G} =15 Ω Inductive Load T_{C} =25 $^{\circ}$ C	-	47	-	ns
t _r	Turn-on Rise Time		-	102	-	ns
t d(off)	Turn-off Delay Time		-	116	-	ns
t f	Turn-off Fall Time		-	109	-	ns
Eon	Turn-on Switching Loss		-	2.09	-	mJ
Eoff	Turn-off Switching Loss		-	0.92	-	mJ
Ets	Total Switching Loss		-	3.01	-	mJ
C _{ies}	Input Capacitance	V _{CE} =25V V _{GE} =0V	-	3600	-	рF
C _{oes}	Output Capacitance		-	120	-	pF
C _{res}	Reverse Transfer Capacitance	f = 1MHz	-	65	-	pF

Electrical Characteristics of Diode (Tc=25℃ unless otherwise noted)

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Units
V_{F}	Diode Forward Voltage	I _F =25A	1	2.05	2.8	V
trr	Diode Reverse Recovery Time	V _{CE} = 600V		252		ns
Irr	Diode peak Reverse Recovery Current	I _F = 25A	•	14		Α
Qrr	Diode Reverse Recovery Charge	Rg=15 Ω	-	1122		nC

Notes:

1. Repetitive Rating: Pulse width limited by maximum junction temperature



Typical Performance Characteristics

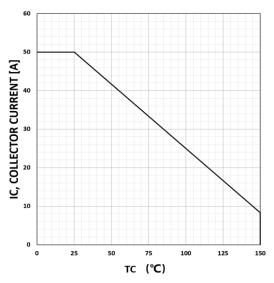


Figure 1. Maximum DC collector current VS. case temperature

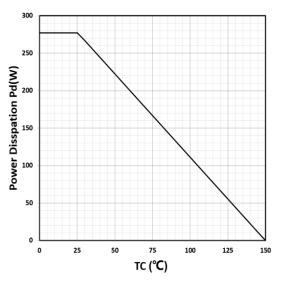


Figure 2. Power dissipation VS. case temperature

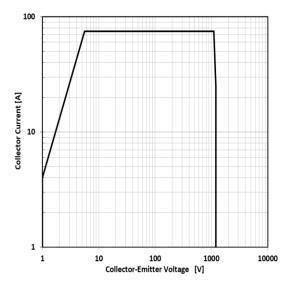


Figure 3. Reverse bias SOA, Tj=125 $^{\circ}$ C,Vge=15V

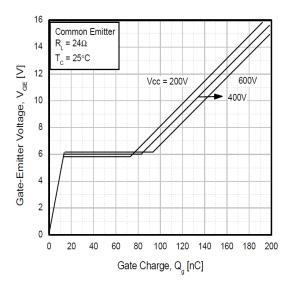


Figure4:Typical gate charge VS. VGE,IC=25A



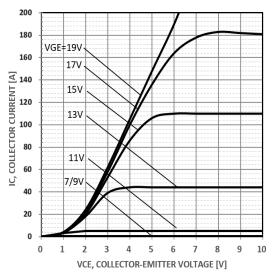


Figure 5. Typical output characteristics $tp{=}300us \;\; Tc{=}25{^\circ}\! C$

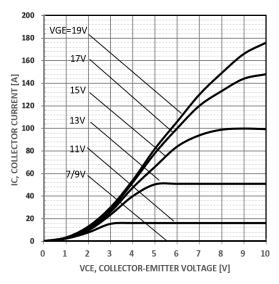


Figure 6. Typical output characteristics tp=300us Tc=150°C

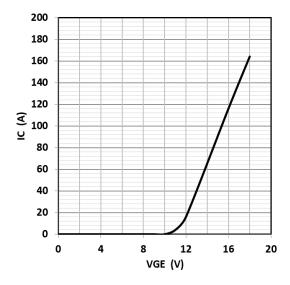


Figure 7. Typical gate threshold voltage

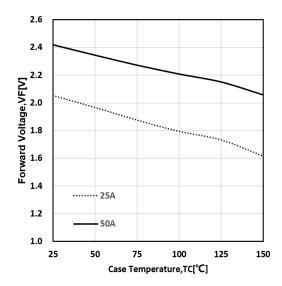


Figure 8. Typical forward voltage vs Tc





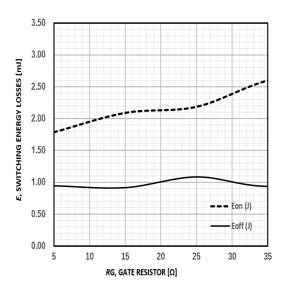


Figure9: Typical energy loss VS. Rg,TC=25°C, VCE=600V, VGE=15V ,IC=25A

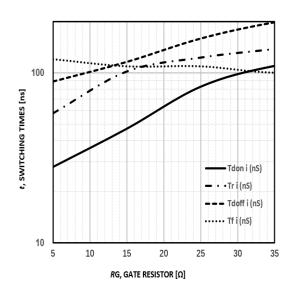


Figure 10: Typical switching time VS. Rg,TC=25°C, VCE=600V, VGE=15V ,IC=25A

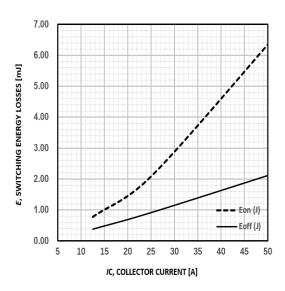


Figure11: Typical energy loss VS. IC, TC=25°C, $\label{eq:VCE=600V} VGE=15V \ , RG=15\Omega$

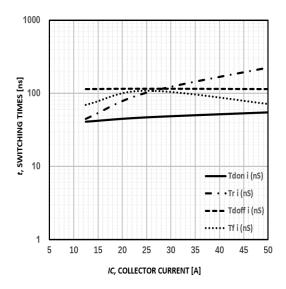


Figure 12: Typical switching time VS. IC, TC=25°C, VCE=600V, VGE=15V,RG=15 Ω





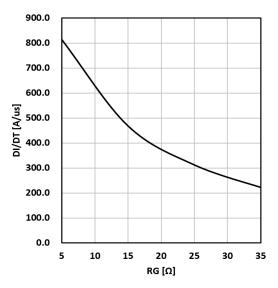


Figure 13. Typical diode di/dt vs rg $\mbox{ Tc=25\,^{\circ}C}$ VCE=600V VGE=15V $\mbox{ IF=25A}$

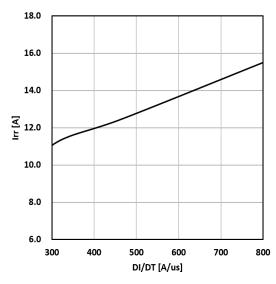


Figure 14. Typical diode irr vs di/dt Tc=25℃ VCE=600V VGE=15V IF=25A

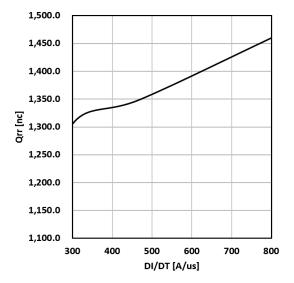


Figure 15. Typical diode Qrr vs di/dt Tc=25°C VCE=600V VGE=15V IF=25A

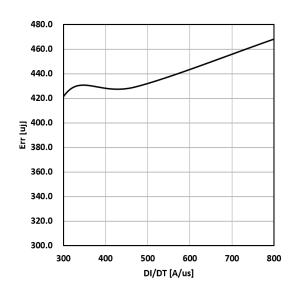


Figure 16. Typical diode Err vs di/dt Tc=25°C VCC=600V VGE=15V IF=25A



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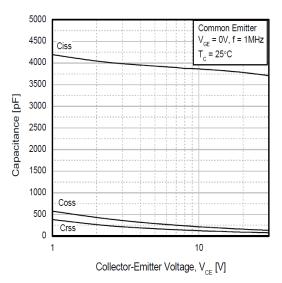


Figure17:Typical capacitance VS. VCE, VGE=0V,f=1MHz

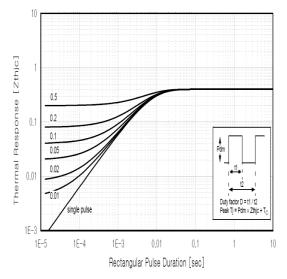
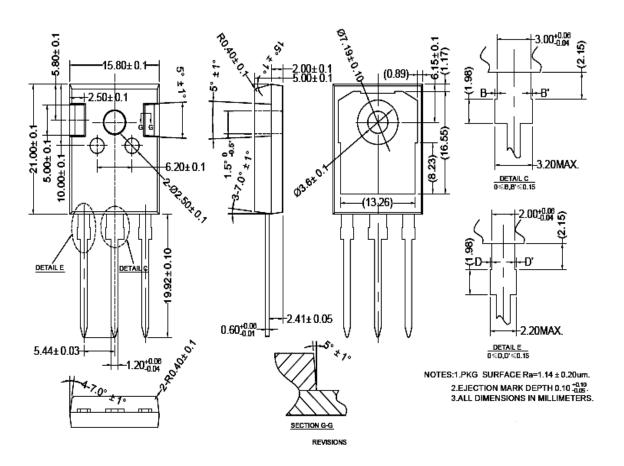


Figure 18. normalized transient thermal impedance, junction-to-case



TO247 PACKAGE OUTLINE



公差标注	会差值	表面粗糙度
0	±0.2	Ra3.2~6.3
0.0	±0.1	Ra1.6~3.2
0.00	±0.01	Ra0.8~1.6
0.000	±0.005	Ra0.4~0.8
0.0000	±0.002	Ra0.2~0.4

0≤D,D'≤0.15

NOTES:1.PKG SURFACE Ra=1.14 ± 0.20um. 2.EJECTION MARK DEPTH 0.10 ± 0.10 3.ALL DIMENSIONS IN MILLIMETERS.



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